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Docket No.

Declaration For U.S. Patent Application

My residence, post I believe I am the or names are listed bel	inventor, I hereby declare that: office address and citizenship ar	re as stated below my na fonly one name is listed is claimed and for which	I below) or an original, first and jo th a patent is sought on the invention	oint inventor (if plural on entitled
the specification of	which is attached hereto unless t	the following box is che	cked:	
was filed	on		as PCT International A	pplication
Number _	An	and was a	nended onas United States Applic	ration
and/or was filed Number	on	and was a	nended onas United States Applic	·
I hereby state that I h by any amendment of I acknowledge the di I hereby claim forei certificate, or §365(below and have also	nave reviewed and understand the referred to above. Huty to disclose information which go priority benefits under 35 U.S. a) of any PCT International applicational applications.	contents of the above-id th is material to patenta S.C. §119(a)-(d) or §365 ication which designate pplication for patent or	entified specification, including the polity as defined in 37 C.F.R. §1.5 (b) of any foreign application(s) for at least one country other than the inventor's certificate or PCT Interpretations.	claim(s), as amended 6. r patent or inventor's the United States, listed mational Application
		•	10/01/2001	Priority Claimed **ED Yes **D No
(List prior	P. 2001-003056 (Number)	Japan (Country)	(Day/Month/Year Filed)	
foreign applications.	P. 2001-325604	Japan (Country)	23/10/2001 (Day/Month/Year Filed)	_
See note A	(Number)			_ O Yes O No
this page)	(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the b			ovisional application(s) listed below	<i>t</i> .
	(Application Number)	(Filing	Date)	
	(Application Number)	(Filing	Date)	
(See Note B on bac of this page)	k 🔲 See attached li	st for additional prior f	oreign or provisional applications.	
designating the Unit disclosed in the prior the duty to disclose filing date of the pr	ed States of America listed below	v and, insofar as the sub the manner provided b patentability as defined	ion(s) or §365(c) of any PCT Internect matter of each of the claims of the first paragraph of 35, U.S.C. in 37 C.F.R. §1.56 which became and date of this application.	this application is not §112. I acknowledge
(List prior U.S. Applications or PCT International	(Application Serial No.)	(Filing Date)	. (Status) (patented, p	pending, abandoned)
applications designating the U.S.)	(Application Serial No.)	(Filing Date)	(Status) (patented, p	pending, abandoned)
George E. Oram, J Goldhush, Reg. No. 37 500: 1:	Ir., Reg. No. 27,931; Robert B o. 33,125; Monica Chin Kitts, ames A. Poulos III, Reg. No. 31	. Murray, Reg. No. 22 Reg. No. 36,105; Ri .714; Patrick D. Muir,	. 22,663; Charles M. Marmelsteir, 980; E. Marcie Emas, Reg. No. chard J. Berman, Reg. No. 39,10 Reg. No. 37,403; Sharon N. Klesned N. Alexander Nolte, Reg. No. 45	32,131; Douglas H. 07; King L. Wong, er, Reg. No. 36,335;
Please direct all cor	mmunications to the following ac	1050 Connecti Washington, I	KINTNER PLOTKIN & KAHN, I cut Avenue, N.W., Suite 600 D.C. 20036-5339	
are believed to be to	must and further that these stated	y own knowledge are to nents were made with th th, under Section 1001 o	. (202) 857-6000; Facsimile No. (2 be and that all statements made on it e knowledge that willful false states of Title 18 of the United States Code issued thereon.	nformation and belief ments and the like so
(See Note C	Full name of sole or first inve	intor <u>A</u>	Masashi TANAKA	
on back of	Inventor's signature	rashi Janah	De	ecember 25, 200
this page)		a, Japan		Date .
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OSI Office AddressC/	O HONDA NAD CO., BID., 4-I, Chido I.	one of many supering supering
<u>•</u>	ventor, if any	
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Full name of sixth joint in	ventor, if any	
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